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Atty. Dkt. No.

5298-06500 PM01026

Inventor(s):

Krishnaswamy Ramkumar

Steven S. Hedayati

Title:

METHOD OF FORMING

SEMICONDUCTOR STRUCTURES

WITH REDUCED STEP HEIGHTS

CERTIFICATE OF EXPRESS MAIL UNDER 37 C.F.R. § 1.10

"Express Mail" mailing label no. EL824777175US Date of Deposit: December 4, 2001

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Patent & Trademark Office, Box: Patent Applications, P.O. Box 2327, Arlington, VA 22202.

Derrick Brown



## **UTILITY PATENT APPLICATION TRANSMITTAL**

(For new non-provisional applications under 37 CFR § 1.53(b))

## Enclosed are the following items:

The Commissioner is hereby authorized to charge the filing fee to Conley, Rose & Tayon, P.C. deposit account no. 50-1505/5298-06500. A duplicate of this page is enclosed. The filing fee is calculated as shown below.

Total Claims	30	-20 =	10	x \$18.00 =	\$180.00
Independent Claims	3	-3 =	0	x \$84.00 =	\$0.00
Multiple Dependent Claims				Fee:	
Basic Fee:					\$ 740.00
				Total:	\$ 920.00

- 2. Request & Certification under 35 U.S.C. 122(b)(2)(B)(i).
- Patent application which includes: 20 pg. disclosure; 5 pg. claims (1-30); 1 pg. abstract. 3.
- Informal drawings of Figs. 1 6 on 3 sheets. 4.
- Newly executed Declaration/Power of Attorney. 5.
- 6. Newly executed Assignment w/cover sheet.
- 7. Return receipt postcard.

ectfully submitted,

Reg. No. 34,146

Attorney for Applicants

Conley, Rose & Tayon

P.O. Box 398

Austin, TX 78767-0398 Date: December 4, 2001

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> > Derrick Brown

## REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Atty Docket Number: 5298-06500

First Named Inventor: Krishnaswamy Ramkumar et al.

Title: METHOD OF FORMING SEMICONDUCTOR STRUCTURES WITH REDUCED STEP HEIGHTS

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 12265).

December 4, 2001

Date

Kevia L. Daffer, Reg. No. 34,146

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant must notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).